

Application Data Sheet

Application Information

Application number:: Not Yet Assigned
Application Type:: Regular
Subject Matter:: Utility
Suggested Group Art Unit:: N/A
CD-ROM or CD-R?:: None
Sequence submission?:: None
Computer Readable Form (CRF)?:: No
Title:: SEMICONDUCTOR COMPONENT AND
METHOD FOR PRODUCING SAME
Attorney Docket Number:: 543822002200
Request for Early Publication?:: No
Request for Non-Publication?:: No
Small Entity?:: No
Petition included?:: No
Secrecy Order in Parent Appl.?:: No

Applicant Information

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Germany
Status:: Full Capacity
Given Name:: Harry
Family Name:: HEDLER
City of Residence:: Germering
Country of Residence:: Germany
Street of mailing address:: Jahnstraße 8
City of mailing address:: Germering
Country of mailing address:: Germany
Postal or Zip Code of mailing address:: 82110

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Germany
Status:: Full Capacity
Given Name:: Simon
Family Name:: MUFF
City of Residence:: Höhenkirchen
Country of Residence:: Germany
Street of mailing address:: Esterwagnerstraße 24
City of mailing address:: Höhenkirchen
Country of mailing address:: Germany
Postal or Zip Code of mailing address:: 85635

Correspondence Information

Correspondence Customer Number:: 25227

Representative Information

Representative Customer Number:: 25227

Foreign Priority Information

Country::	Application number::	Filing Date::	Priority Claimed::
Germany	102 55 848.5	November 29, 2002	Yes

Assignee Information

Assignee name:: Infineon Technologies AG
Street of mailing address:: St.-Martin Strasse 53
City of mailing address:: München
Country of mailing address:: Germany
Postal or Zip Code of mailing address:: 81669